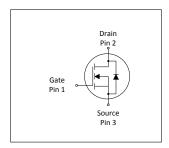


MOSFET

600V CoolMOS™ CFD7 Power Transistor

CoolMOSTM is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. The latest CoolMOSTM CFD7 is the successor to the CoolMOSTM CFD2 series and is an optimized platform tailored to target soft switching applications such as phase-shift full-bridge (ZVS) and LLC. Resulting from reduced gate charge (Qg), best-in-class reverse recovery charge (Qrr) and improved turn off behavior CoolMOSTM CFD7 offers highest efficiency in resonant topologies. As part of Infineon's fast body diode portfolio, this new product series blends all advantages of a fast switching technology together with superior hard commutation robustness, without sacrificing easy implementation in the design-in process. The CoolMOSTM CFD7 technology meets highest efficiency and reliability standards and furthermore supports high power density solutions. Altogether, CoolMOSTM CFD7 makes resonant switching topologies more efficient, more reliable, lighter and cooler.

PG-TO 247-3









Features

- Ultra-fast body diode
- Low gate charge
- Best-in-class reverse recovery charge (Q_{rr})
- Improved MOSFET reverse diode dv/dt and di_F/dt ruggedness
- Lowest FOM R_{DS(on)}*Q_g and R_{DS(on)}*E_{oss}
- Best-in-class R_{DS(on)} in SMD and THD packages

Benefits

- Excellent hard commutation ruggedness
- Highest reliability for resonant topologies
- Highest efficiency with outstanding ease-of-use / performance tradeoff
- Enabling increased power density solutions

Potential applications

Suiteable for Soft Switching topologies Optimized for phase-shift full-bridge (ZVS), LLC Applications – Server, Telecom, EV Charging

Product Validation: Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.

Table 1 Key Performance Parameters

Table 1 Roy 1 of formation 1 aramotore								
Parameter	Value	Unit						
V _{DS} @ T _{j,max}	650	V						
R _{DS(on),max}	18	mΩ						
$Q_{g,typ}$	251	nC						
I _{D,pulse}	495	A						
E _{oss} @ 400V	28.8	μJ						
Body diode di _F /dt	1300	A/µs						

Type / Ordering Code	Package	Marking	Related Links
IPW60R018CFD7	PG-TO 247-3	60R018F7	see Appendix A

600V CoolMOS™ CFD7 Power Transistor IPW60R018CFD7



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IPW60R018CFD7



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	0		Value	s	Unit	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.		Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	101 64.0	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	495	Α	T _C =25°C	
Avalanche energy, single pulse	E AS	-	-	582	mJ	I _D =9.3A; V _{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	2.91	mJ	I _D =9.3A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	9.3	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	416	W	<i>T</i> _C =25°C	
Storage temperature	$T_{ m stg}$	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	Is	-	-	101	Α	<i>T</i> _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	495	Α	<i>T</i> _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	V _{DS} =0400V, I _{SD} <=101A, T _j =25°C see table 8	
Maximum diode commutation speed	di _F /dt	-	-	1300	A/μs	V _{DS} =0400V, I _{SD} <=101A, T _j =25°C see table 8	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, <i>t</i> =1min	

 $^{^{1)}}$ Limited by $T_{j\,\text{max}}.$ $^{2)}$ Pulse width t_p limited by $T_{j,\text{max}}$ $^{3)}$ Identical low side and high side switch with identical R_G

IPW60R018CFD7



2 Thermal characteristics

Table 3 Thermal characteristics

Davamatav	Complete	Values			11:4	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.3	°C/W	-
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R_{thJA}	-	-	-	°C/W	n.a.
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s

IPW60R018CFD7



Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 **Static characteristics**

Danamatan	Oh l		Values			Note / Tool Open Hittory
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V_{GS} =0V, I_D =1mA
Gate threshold voltage	V _{(GS)th}	3.5	4	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 2.91 {\rm mA}$
Zero gate voltage drain current ¹⁾	I _{DSS}	-	- 60	1 241	μΑ	V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =125°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.015 0.029	0.018	Ω	V _{GS} =10V, I _D =58.2A, T _j =25°C V _{GS} =10V, I _D =58.2A, T _j =150°C
Gate resistance	R _G	-	2.7	-	Ω	f=1MHz, open drain

Dynamic characteristics Table 5

Parameter.	Ob. a.l		Values			Nata (Tant Oan dition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	C _{iss}	-	9901	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Output capacitance	Coss	-	196	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Effective output capacitance, energy related ²⁾	C _{o(er)}	-	361	-	pF	V _{GS} =0V, V _{DS} =0400V	
Effective output capacitance, time related ³⁾	C _{o(tr)}	-	3730	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V	
Turn-on delay time	t _{d(on)}	-	80	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =21.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Rise time	t _r	-	35	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =21.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Turn-off delay time	$t_{ m d(off)}$	-	220	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =21.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Fall time	t _f	-	8	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =21.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	

Table 6 **Gate charge characteristics**

Developer	C. mah al		Values			Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	54	-	nC	V_{DD} =400V, I_{D} =21.8A, V_{GS} =0 to 10V
Gate to drain charge	$Q_{ m gd}$	-	90	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =21.8A, $V_{\rm GS}$ =0 to 10V
Gate charge total	Qg	-	251	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =21.8A, $V_{\rm GS}$ =0 to 10V
Gate plateau voltage	V _{plateau}	-	5.3	-	V	V_{DD} =400V, I_{D} =21.8A, V_{GS} =0 to 10V

 $^{^{1)}}$ Maximum specification is defined by calculated six sigma upper confidence bound $^{2)}$ $C_{\rm o(er)}$ is a fixed capacitance that gives the same stored energy as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V $^{3)}$ $C_{\rm o(tr)}$ is a fixed capacitance that gives the same charging time as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V

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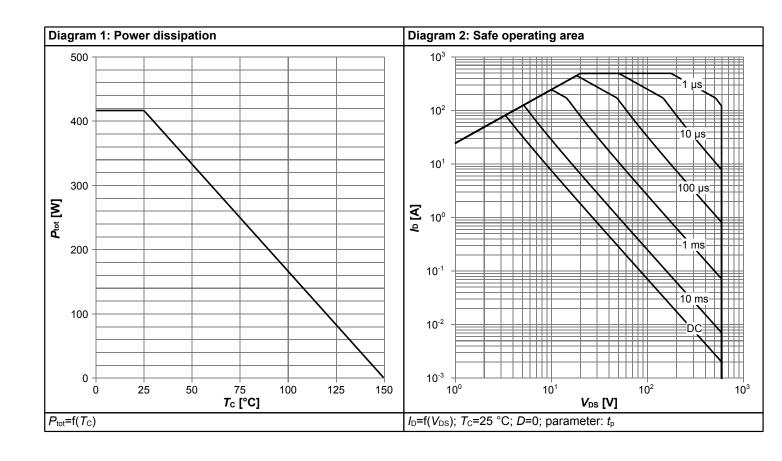


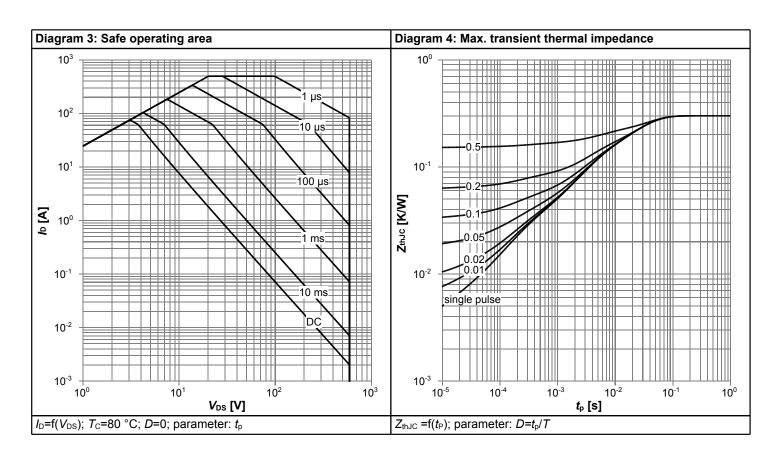
Table 7 Reverse diode characteristics

Developed	Symbol	Values			11:4	Nata / Tant Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	1.0	-	V	V _{GS} =0V, I _F =58.2A, T _j =25°C
Reverse recovery time	t _{rr}	-	223	446	ns	V_R =400V, I_F =21.8A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	1.56	3.12	μC	V_R =400V, I_F =21.8A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	_	13	-	А	V_R =400V, I_F =21.8A, di_F/dt =100A/ μ s; see table 8

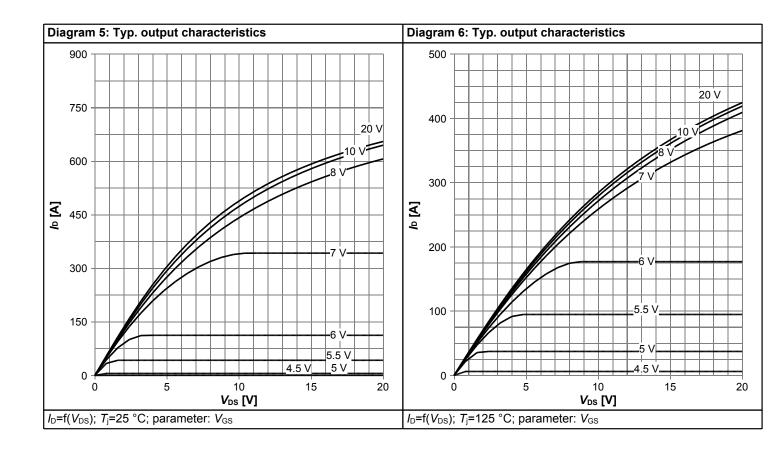


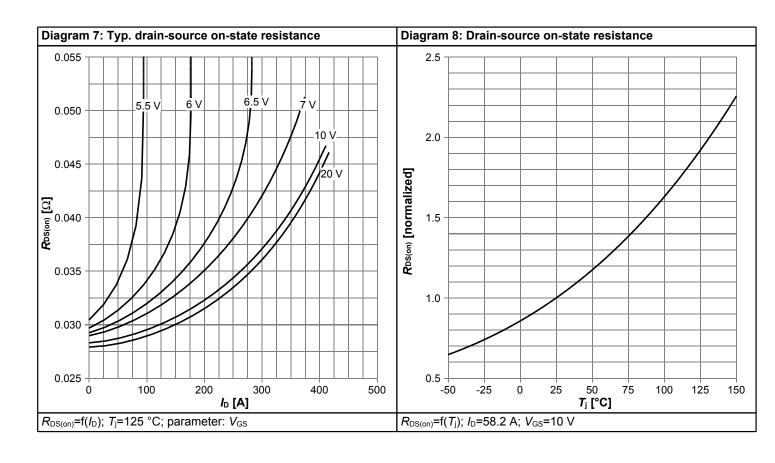
4 Electrical characteristics diagrams



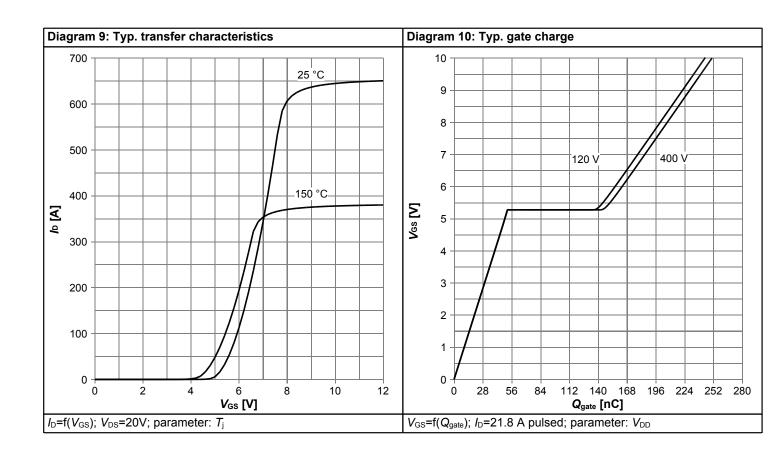


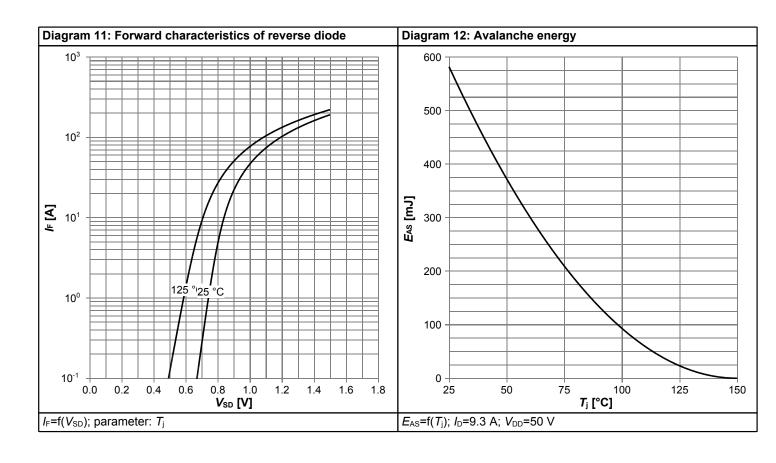




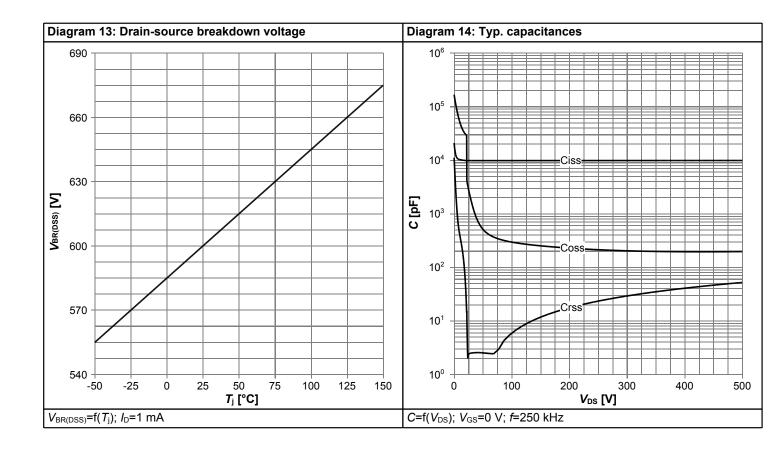


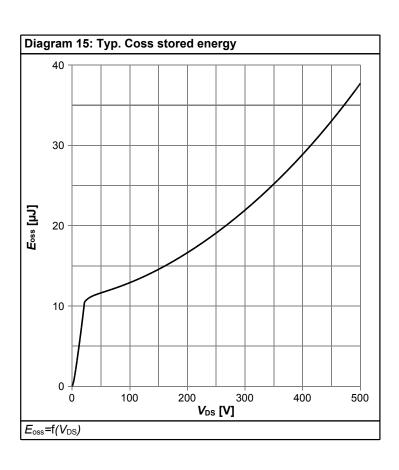
















5 **Test Circuits**

Table 8 **Diode characteristics**

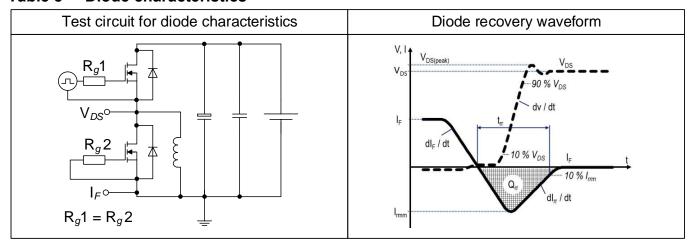


Table 9 **Switching times**

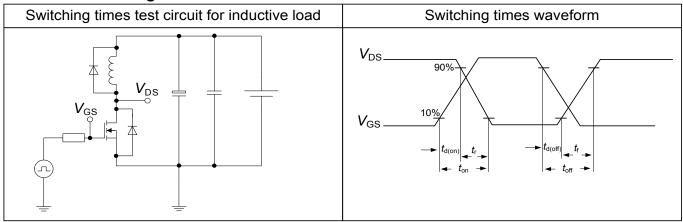
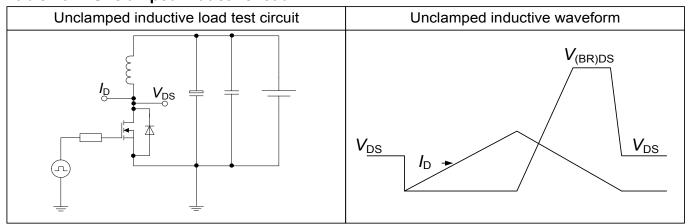


Table 10 **Unclamped inductive load**





6 Package Outlines

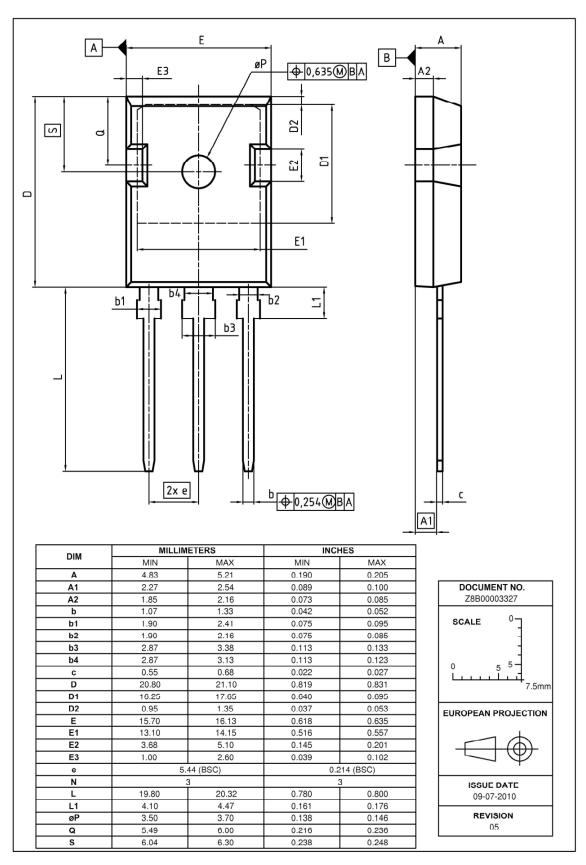


Figure 1 Outline PG-TO 247-3, dimensions in mm/inches

600V CoolMOS™ CFD7 Power Transistor IPW60R018CFD7



7 Appendix A

Table 11 Related Links

• IFX CoolMOS CFD7 Webpage: www.infineon.com

• IFX CoolMOS CFD7 application note: www.infineon.com

• IFX CoolMOS CFD7 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

IPW60R018CFD7



Revision History

IPW60R018CFD7

Revision: 2018-04-24, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2018-04-24	Release of final version

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